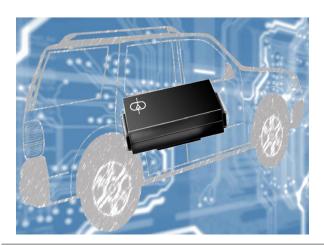


# **SURFACE MOUNT ULTRA FAST RECTIFIER**

## **DESCRIPTION:**



The ALPAMUS1M is Surface Mount Ultra Fast Rectifier with High forward surge capability in Low profile package, low switching losses and it has high efficiency operation.

ALPAMUS1M is **AEC-Q101 approved** and meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C use in freewheeling application in switching mode converters and inverters for automotive.

FEATURES: APPLICATIONS:

- > AEC-Q101 approved.
- > Low profile package.
- Ideal for automated placement.
- Glass passivated pallet chip junction.
- Ultrafast reverse recovery time.
- Low switching losses, high efficiency.
- High forward surge capability.
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C.
- HALOGEN Free.
- RoHS Compliant.
- REACH Compliant.

Automotive application.



# **TYPICAL DEVICE CHARACTERISTICS**

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	ALPAMUS1M	UNIT	
Maximum repetitive peak reverse voltage	$V_{RRM}$	1000	V	
Maximum RMS voltage	V <sub>RMS</sub>	700	V	
Maximum DC blocking voltage	V <sub>DC</sub>	1000	V	
Maximum average forward rectified current at $T_L = 110 ^{\circ}\text{C}$	I <sub>F(AV)</sub>	1.0	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30	А	
Operating and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	1.0 A		
V <sub>RRM</sub>	50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V		
I <sub>FSM</sub>	30 A		
t <sub>rr</sub>	50 ns, 75 ns		
V <sub>F</sub> at I <sub>F</sub>	1.0 V, 1.7 V		
T <sub>J</sub> max.	150 °C		
Package	SMA (DO-214AC)		
Diode variations	Single		

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<b>THERMAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	ALPAMUS1M	UNIT
Maximum thermal resistance	$R_{\theta JA}^{~(1)}$	75	°C /\\
	R <sub>θJL</sub> <sup>(1)</sup>	27	°C/W
Note			

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	TEST CONDITIONS	SYMBOL	ALPAMUS1M	UNIT
Maximum instantaneous forward voltage	1.0 A	V <sub>F</sub> (1)	1.7	V
	T <sub>A</sub> = 25 °C		10	
Maximum DC reverse current at rated DC blocking voltage	T <sub>A</sub> = 100 °C	I <sub>R</sub>	50	μΑ
Maximum reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A	t <sub>rr</sub>	75	ns
Typical junction capacitance	4.0 V, 1 MHz	CJ	10	pF
Note			•	



# TYPICAL DEVICE CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

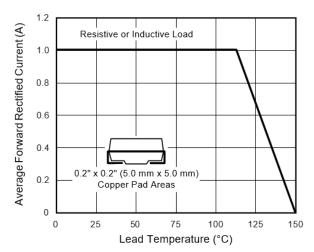


Fig.1 Forward Current Derating Curve

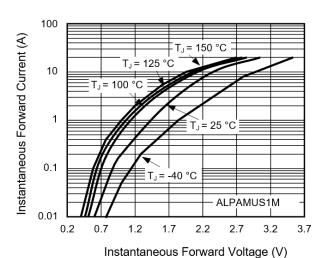


Fig.3 Typical Instantaneous Forward Characteristics

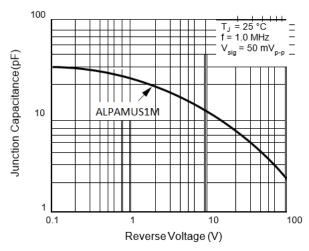


Fig.5 Typical Junction Capacitance

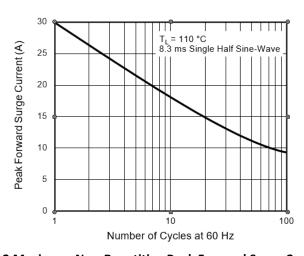


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

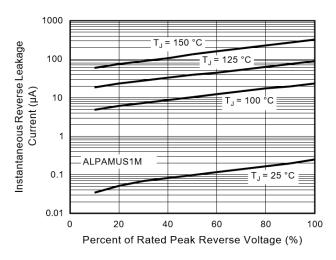


Fig.4 Typical Reverse Leakage Characteristics

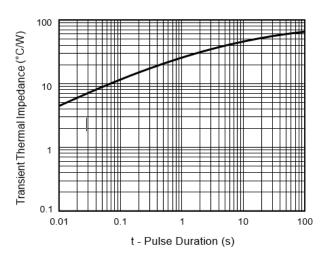
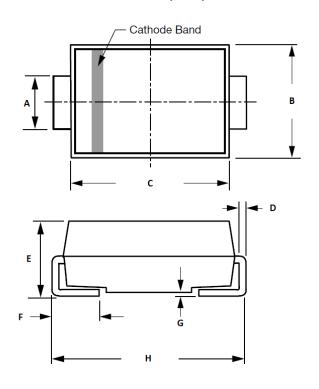


Fig. 6 Typical Transient Thermal Impedance



# **PACKAGE INFORMATION**

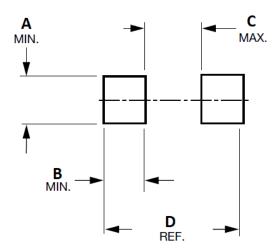
## **DO-214AC (SMA)**



	OUTLINE DIMENSIONS			
DIM	MILLI	METERS	INCHI	ES
DIIVI	MIN	MAX	MIN	MAX
А	1.25	1.65	0.049	0.065
В	2.54	2.79	0.100	0.110
С	3.99	4.50	0.157	0.177
D	0.152	0.305	0.006	0.012
E	1.98	2.29	0.078	0.090
F	0.76	1.52	0.030	0.060
G	0	0.203	0	0.008
Н	4.93	5.28	0.194	0.208

#### NOTES

- Controlling dimension: millimeters.
- Dimensioning and tolerances per ANSI Y14.5M, 1985.
  Dimensions are exclusive of mold flash and metal burrs.



PAD LAYOUT DIMENSIONS						
	MILLIN	METERS INCH		MILLIMETERS INCHES		HES
DIM	MIN	MAX	MIN	MAX		
А	1.68	-	0.066	-		
В	1.52	-	0.060	-		
С	-	1.88	-	0.074		
D	5.28	-	0.208	-		
NOTES						
1. Controlling dimension: millimeters.						



#### **CUSTOMER NOTE:**

#### **DISCLAIMER**

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- 1. ALPINESEMI™ Semiconductor Devices are RoHS compliant and hence customers are requested to dispose as per the prevailing Environmental Legislation put forth in their specific country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).



sales@alpinesemi.com www.alpinesemi.com